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April 1<sup>st</sup>, 2010 Renesas Electronics Corporation

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# RENESAS

# 7548/49 Group, 7544 Group (QzROM)

Differences between 7548/49 Group and 7544 Group (QzROM)

# 1. Differences between 7548/49 Group and 7544 Group (QzROM)

	7544 Crown (0-DOM)	7544 Group (OzBOM) 7548/49 Group		
	7544 Group (QzROM)	7548	7549	
Applicable Product	M37544G2A-XXXSP/GP M37544G2ASP/GP	M37548G3-XXXFP M37548G3FP M37548G2-XXXFP M37548G2FP M37548G1-XXXFP M37548G1FP	M37549G3-XXXFP M37549G3FP M37549G2-XXXFP M37549G2FP M37549G1-XXXFP M37549G1FP	
Package	PRDP0032BA-A (32P4B): 32-pin SDIP PLQP0032GB-A (32P6U-A): 32-pin LQFP	PLSP0020JB-A (20P2F-A): 20-pin SSOP		
ROM Type: ROM/RAM Size (Bytes)	QzROM: 2K/192 (for G1)           QzROM: 8K/256         QzROM: 4K/256 (for G2)           QzROM: 6K/256 (for G3)         QzROM: 6K/256 (for G3)		)	
Programmable I/O	25	15	19	
LED Ports	14 (Total electrical current: 60 mA)	8		
Intomata	12 sources, 12 vectors	12 sources, 12 vectors		
Interrupts	(five external sources)	(four external sources)		
Timer	8-bit x 2 (Timer 1, X)	8-bit x 2 (Timer 1, 2)		
Third	16-bit x 1 (Timer A)	16-bit x 1 (Timer A)		
Output Compare	Not available	3-channels		
Input Capture	Not available	1-channel		
A/D Converter	8-bit x 6-channels	10-bit x 6-channels	10-bit x 8-channels	
		High-speed: 4MHz(Typ.)		
On-Chip Oscillator	2MHz(Typ.)	Low-speed: 250kHz(Typ.)		
Power-On Reset	Not available	Built-in type		
Low Voltage Detection Circuit	Not available	Built-in type		
Power Source Voltage (ceramic oscillation)	2.2 to 5.5 V	1.8 to 5.5 V		
Power Source Voltage (on-chip oscillator)	1.8 to 5.5V @2MHz	4.0 to 5.5V @4MHz 1.8 to 5.5V @250kHz		
Function Set ROM Area	Address FFD4 <sub>16</sub>	Addresses FFD4 <sub>16</sub> to FFDB <sub>16</sub>		

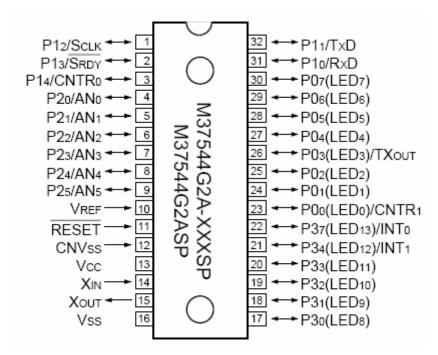


(cont.)			
Function Set ROM Data	Not available	Built-in type	
Oscillation Method Selection	Not available	Available	
Low-speed On-chip Oscillator Control	Not available	Available	
STP Instruction Function Selection	Not available	Available	
WDT H Count Source Selection	Not available	Available	
WDT Source Clock Selection	Not available	Available	
WDT Disable Bit	Not available	Available	
LVD Circuit Valid Bit	Not available	Available	
LVD Valid Bit in STP Mode	Not available	Available	

## 2. Pin Configuration of 7548/49 Group and 7544 Group (QzROM)

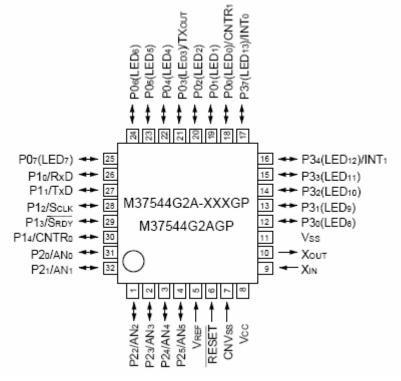
The 7548/49 Group and 7544 Group (QzROM) are NOT pin compatible. The differences of the pin configuration and package type are indicated below.

## 7544 Group (QzROM) Pin Configuration & Package Type



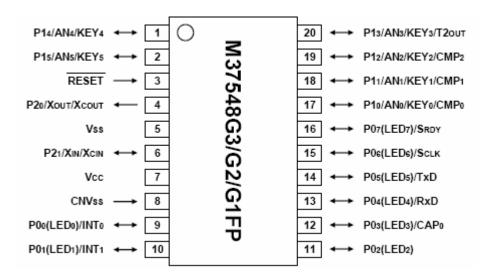
Package type: PRDP0032BA-A (32P4B)





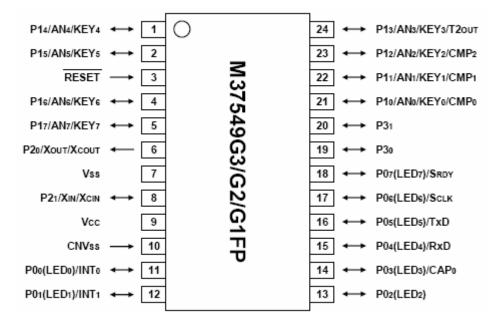
Package type: PLQP0032GB-A (32P6U-A)

# 7548/49 Group Pin Configuration & Package Type



Package type: PLSP0020JB-A (20P2F-A)







### 3. SFR of 7548/49 Group and 7544 Group (QzROM)

The differences of the SFRs between the 7548/49 Group and 7544 Group (QzROM) are indicated below.

	7544 Group (QzROM)	7548/49 Group
000016	Port P0 (P0)	Port P0 (P0)
000116	Port P0 direction register (P0D)	Port P0 direction register (P0D)
000216	Port P1 (P1)	Port P1 (P1)
0003 <sub>16</sub>	Port P1 direction register (P1D)	Port P1 direction register (P1D)
0004 <sub>16</sub>	Port P2 (P2)	Port P2 (P2)
$0005_{16}$	Port P2 direction register (P2D)	Port P2 direction register (P2D)
0006 <sub>16</sub>	Port P3 (P3)	Port P3 (P3) *only 7549
$0007_{16}$	Port P3 direction register (P3D)	Port P3 direction register (P3D)*only 7549
$0008_{16}$	Reserved	Reserved
0009 <sub>16</sub>	Reserved	Reserved
$000A_{16}$	Reserved	Reserved
$000B_{16}$	Reserved	Reserved
$000C_{16}$	Reserved	Port P0 drive capacity control register (DCCR)
$000D_{16}$	Reserved	Port P0 Pull-up control register (PULL0)
$000E_{16}$	Reserved	Port P1 Pull-up control register (PULL1)
$000F_{16}$	Reserved	Key-on wake-up input select register(KEYS)
0010 <sub>16</sub>	Reserved	Capture/compare register (low-order) (CRAL)
$0011_{16}$	Reserved	Capture/compare register (high-order) (CRAH)
0012 <sub>16</sub>	Reserved	Capture/compare register R/W pointer (CCRP)
001316	Reserved	Compare output mode register (CMOM)
0014 <sub>16</sub>	Reserved	Timer A (low-order) (TAL)
0015 <sub>16</sub>	Reserved	Timer A (high-order) (TAH)



	7544 Group (QzROM)	7548/49 Group
0016 <sub>16</sub>	Pull-up control register (PULL)	Reserved
0017 <sub>16</sub>	Port P1P3 control register (P1P3C)	Reserved
0018 <sub>16</sub>	Transmit/Receive buffer register (TB/RB)	Transmit/Receive buffer register (TB/RB)
0019 <sub>16</sub>	Serial I/O status register (SIOSTS)	Serial I/O status register (SIOSTS)
001A <sub>16</sub>	Serial I/O control register (SIOCON)	Serial I/O control register (SIOCON)
001B <sub>16</sub>	UART control register (UARTCON)	UART control register (UARTCON)
001C <sub>16</sub>	Baud rate generator (BRG)	Baud rate generator (BRG)
001D <sub>16</sub>	Timer A mode register (TAM)	Reserved
001E <sub>16</sub>	Timer A (low-order) (TAL)	Reserved
001F <sub>16</sub>	Timer A (high-order) (TAH)	Reserved
002016	Reserved	Reserved
002116	Reserved	Reserved
0022 <sub>16</sub>	Reserved	Reserved
0023 <sub>16</sub>	Reserved	Reserved
0024 <sub>16</sub>	Reserved	Reserved
0025 <sub>16</sub>	Reserved	Reserved
002616	Reserved	Reserved
0027 <sub>16</sub>	Reserved	Reserved
002816	Prescaler 1 (PRE1)	Prescaler 12 (PRE12)
0029 <sub>16</sub>	Timer 1 (T1)	Timer 1 (T1)
002A <sub>16</sub>	Reserved	Timer 2 (T2)
$002B_{16}$	Timer X mode register (TXM)	Timer mode register (TM)
$002C_{16}$	Prescaler X (PREX)	Timer count source set register (TCSS)
$002D_{16}$	Timer X (TX)	Compare register re-load register (CMPR)
$002E_{16}$	Timer count source set register1 (TCSS1)	Capture/compare port register (CCPR)
$002F_{16}$	Timer count source set register2 (TCSS2)	Capture/compare status register (CCSR)
003016	Reserved	Compare interrupt source set register (CISR)
003116	Reserved	Capture software trigger register (CSTR)
003216	Reserved	Capture mode register (CAPM)
003316	Reserved	Reserved
003416	A/D control register (ADCON)	A/D control register (ADCON)
0035 <sub>16</sub>	A/D register (AD)	A/D conversion register (low-order) (ADL)
003616	Reserved	A/D conversion register (high-order) (ADH)
0037 <sub>16</sub>	Reserved	Clock mode register (CLKM)
003816	MISRG	Oscillation stop detection register (CLKSTP)
0039 <sub>16</sub>	Watchdog timer control register (WDTCON)	Watchdog timer control register (WDTCON)
$003A_{16}$	Interrupt edge selection register (INTEDGE)	Interrupt edge selection register (INTEDGE)
$003B_{16}$	CPU mode register (CPUM)	CPU mode register (CPUM)
$003C_{16}$	Interrupt request register 1 (IREQ1)	Interrupt request register 1 (IREQ1)
$003D_{16}$	Interrupt request register 2 (IREQ2)	Interrupt request register 2 (IREQ2)
$003E_{16}$	Interrupt control register 1 (ICON1)	Interrupt control register 1 (ICON1)
$003F_{16}$	Interrupt control register 2 (ICON2)	Interrupt control register 2 (ICON2)
$003F_{16}$	Interrupt control register 2 (ICON2)	

Note: Do not access to the SFR reserved area.

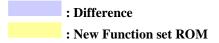
: New SFR in 7548/49

: Changed in 7548/49

#### 4. Function Set ROM Area of 7548/49 Group and 7544 Group (QzROM)

Function set ROM data and addresses are changed to the 7548/49 Group with additional new ROM data as indicated below.

	7544 Group (QzROM)	7548/49 Group
FFD4 <sub>16</sub>	ROM code protect	Renesas shipment test area
FFD5 <sub>16</sub>		Renesas shipment test area
FFD6 <sub>16</sub>		Renesas shipment test area
FFD7 <sub>16</sub>		Renesas shipment test area
FFD8 <sub>16</sub>		Function set ROM data 0
FFD9 <sub>16</sub>		Function set ROM data 1
FFDA <sub>16</sub>		Function set ROM data 2
FFDB <sub>16</sub>		ROM code protect



#### 5. Interrupt Vector of 7548/49 Group and 7544 Group (QzROM)

Interrupt sources and interrupt vector addresses are changed to the 7548/49 Group with additional registers as indicated below. The bits in interrupt request registers and interrupt control registers are also changed. (Please refer to their datasheet for the detail information)

Vector address		Duiouitu	7544 Group (QzROM)	7548/49 Group
High-order	Low-order	Priority	Interrupt Source	Interrupt Source
FFFD <sub>16</sub>	FFFC <sub>16</sub>	1	Reset	Reset
FFFB <sub>16</sub>	FFFA <sub>16</sub>	2	Serial I/O receive	Serial I/O receive
FFF9 <sub>16</sub>	FFF8 <sub>16</sub>	3	Serial I/O transmit	Serial I/O transmit
FFF7 <sub>16</sub>	FFF6 <sub>16</sub>	4	INT <sub>0</sub>	INT <sub>0</sub>
FFF5 <sub>16</sub>	FFF4 <sub>16</sub>	5	INT <sub>1</sub>	INT <sub>1</sub>
FFF3 <sub>16</sub>	FFF2 <sub>16</sub>	6	Key-on wake-up	Key-on wake-up
FFF1 <sub>16</sub>	FFF0 <sub>16</sub>	7	CNTR <sub>0</sub>	Capture
FFEF <sub>16</sub>	FFEE <sub>16</sub>	8	CNTR <sub>1</sub>	Compare
FFED <sub>16</sub>	FFEC <sub>16</sub>	9	Timer X	Timer A
FFEB <sub>16</sub>	FFEA <sub>16</sub>	10	Reserved area	Timer 2
FFE9 <sub>16</sub>	FFE8 <sub>16</sub>	11	Reserved area	A/D conversion
FFE7 <sub>16</sub>	FFE6 <sub>16</sub>	12	Timer A	Timer 1
FFE5 <sub>16</sub>	FFE4 <sub>16</sub>	13	Reserved area	Reserved area
FFE3 <sub>16</sub>	FFE2 <sub>16</sub>	14	A/D conversion	Reserved area
FFE1 <sub>16</sub>	FFE0 <sub>16</sub>	15	Timer 1	Reserved area
FFDF <sub>16</sub>	FFDE <sub>16</sub>	16	Reserved area	Reserved area
FFDD <sub>16</sub>	FFDC <sub>16</sub>	17	BRK instruction	BRK instruction

7544 Group (QzROM) and 7548/49 Group Differences =

#### 6. Clock Generating Circuit of 7548/49 Group and 7544 Group (QzROM)

The differences of clock generating circuit between the 7548/49 Group and 7544 Group (QzROM) are indicated below.

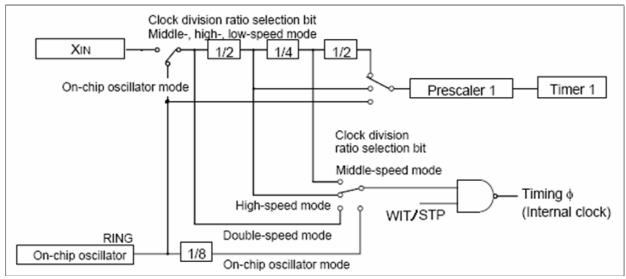


Figure 1 7544 Group (QzROM) Clock Generating Circuit Block Diagram

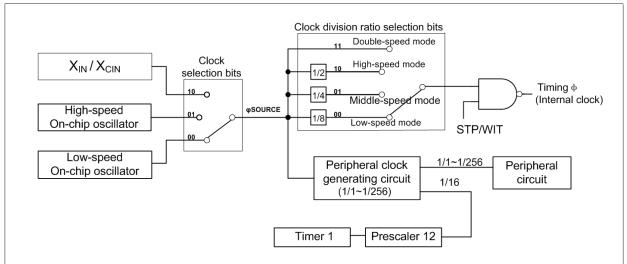


Figure 2 7548/49 Group Clock Generating Circuit Block Diagram



#### 7. Timer of 7548/49 Group and 7544 Group (QzROM)

The differences of timers between the 7548/49 Group and 7544 Group (QzROM) are indicated below. Compared with the 7544 Group (QzROM), some functions of the timer 2 and timer A are reduced in the 7548/49 Group. However, the output compare and input capture functions are added for some special application.

Timer 1 (Prescaler 1)	Count source: f(XIN)/16, f(XIN)/2, or on-chip oscillator output selectable (set using the TCSS2 register)	Timer 1 (Prescaler 12)	Count source: $f(\phi \text{SOURCE})/16$ , or $f(X_{\text{CIN}})$ :32kHz quartz crystal oscillation (set using the CLKM and TCSS register)
	Count source: f(XIN)/16, f(XIN)/2, or on-chip oscillator output selectable (set using the TCSS1 register)		Count source: f(¢SOURCE)/16, f(¢SOURCE)/256, Prescaler 12 output, Timer A underflow (set using the CLKM and TCSS register)
Timer X (Prescaler X)	<ul> <li>Timer X has four operating modes:</li> <li>(set using the TXM register)</li> <li>(1) Timer mode</li> <li>(2) Pulse output mode</li> <li>(3) Event counter mode</li> <li>(4) Pulse width measurement mode</li> </ul>	Timer 2 (Prescaler 12)	<ul><li>Timer 2 has two operating modes:</li><li>(set using the TM register)</li><li>(1) Timer mode</li><li>(2) Pulse output mode</li></ul>
	Count source: f(XIN)/16, f(XIN)/2, or on-chip oscillator output selectable (set using the TCSS2 register)		Count source: f(\$\phi SOURCE)/16, f(\$\phi SOURCE)/2, f(\$\phi SOURCE)/32, f(\$\phi SOURCE)/64, f(\$\phi SOURCE)/128, f(\$\phi SOURCE)/256, f(LSOCO), f(X_{CIN}) (set using the CLKM and TCSS register)
Timer A (16-bit)	<ul> <li>Timer A has four operating modes:</li> <li>(set using the TAM register)</li> <li>(1) Timer mode</li> <li>(2) Period measurement mode</li> <li>(3) Event counter mode</li> <li>(4) Pulse width HL continuously measurement mode</li> </ul>	Timer A (16-bit)	<ul><li>Timer A has three operating modes:</li><li>(1) Timer mode</li><li>(2) Output compare mode</li><li>(3) Input capture mode</li></ul>

#### 7544 Group (QzROM) Timer

#### 7548/49 Group Timer



#### 8. Reference Document

Datasheets 7544 Group Datasheet (QzROM version) 7548 Group Datasheet 7549 Group Datasheet (Use the latest version of the document on the Renesas Technology Web site.)

Technical Update/Technical News

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#### **Revision Record**

Rev.	Date	Description		
Nev. Dale		Page	Summary	
1.00	Oct.07.06	-	First edition issued	
1.01	Mar.05.08	All	7544 Group $\rightarrow$ 7544 Group (QzROM)	
		1	Modified the applicable product name and ROM type of 7544 Group (QzROM)	
		7	Figure 2 updated (Added "XCIN"; sysclk $\rightarrow \Phi$ source; Deleted "System" and "CPU")	
		8	The table content of 7548/49 Group updated	



#### **7548/49 Group, 7544 Group (QzROM)** Differences between 7548/49 Group and 7544 Group (QzROM)

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